

Question #	Question	Answer
3	Can you provide additional detail on the electronics cooling requirement in support of hypersonics? Would this include cooling associated with final guidance, more specifically the seeker? What specific electronics elements within the missile systems is this RFS focused on?	The electronics cooling requirement in support of hypersonics focus mainly on the components inside the glide body such as the thermal batteries, RF units, and IMUs at limit temperatures around 100 C or below. Efforts are already underway in parallel programs to address the missile seeker window that's on the outside of the body at higher temperatures.